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APPLICANT
TAKASHIMA, et al.

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(Use several sheets if necessary)

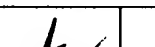

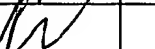
U.S. PATENT DOCUMENTS

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FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER								DATE	COUNTRY	CLASS	SUBCLAS S	ABSTRACT	
													YES	NO
	0	1	0	9	2	4	5	2/8/01	WO		100/114- ROOM 1	RECEIVED 100-9 2012		
	0	9	6	4	0	3	1	12/15/99	Europe					
	0	3	0	1	7	1	9	2/1/89	Europe					
	1	1	8	2	2	2	8	2/27/02	Europe					
	1	0	4	6	6	7	4	10/25/00	Europe					

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	<p>Patent Abstract of Japan, Publication No.: 58160344; Publication Date: 9/22/83; Application Date: 3/17/82; Application No.: 57043429; Applicant: Toyobo Co., Ltd.; Inventor: Akashi Tatsu; HOLLOW POLYESTER MOLDING HAVING EXCELLENT GAS BARRIER PROPERTIES</p>
	<p>Patent Abstracts of Japan, Publication No.: 62181336; Publication Date: 8/8/87; Application Date: 2/6/86; Application No.: 61024483; Applicant: Yoshino Kogyosho Co., Ltd.; Inventor: Koshio Shuchi; MOLDED ARTICLE OF POLYETHYLENE TEREPHTHALATE RESIN.</p>
	<p>Patent Abstracts of Japan, Publication No.: 01320159; Publication Date: 12/26/89; Application No.: 6321/88; Application No.: 63153325; Applicant: Mitsubishi Kasei Corp.; Inventor: Takamiya Naoki; LAMINATED AND ORIENTED MOLDING</p>

EXAMINER

DATE CONSIDERED